



Specifications for LCD module

Customer	
Customer part no.	
Ampire part no.	AM-1280800WNTZQW-T10H
Approved by	
Date	

Preliminary Specification

Formal Specification

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Approved by	Checked by	Organized by
Patrick	Kokai	Mark

This Specification is subject to change without notice.

RECORD OF REVISION

Revision Date	Page	Contents	Editor
2021/06/02		New release	Mark

1. General Descriptions

1.1 Introduction

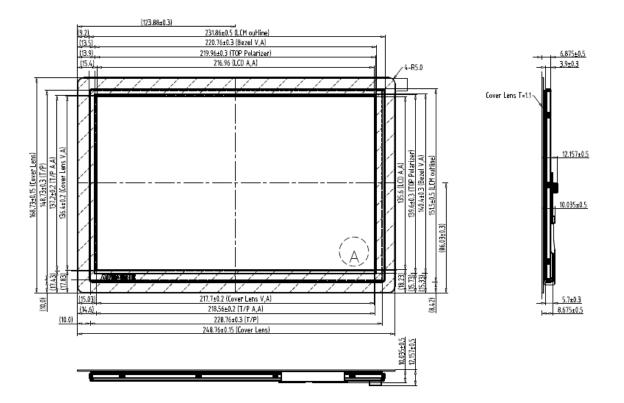
The LCM is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. It is composed of a TFT LCD panel, a backlight system, column driver and row driver circuit. This TFT LCD has a 10.1-inch diagonally measured active display area with WXGA resolution (1280 horizontal by 800 vertical pixels array).

1.2 Features

- (1) 10.1" TFT LCD Panel
- (2) LED Backlight System
- (3) Supported WXGA 1280x800 pixels resolution
- (4) Compatible with RoHS Standard
- (5) Touch panel
 - ♦ IC: EETI EXC3146
 - ♦ Interface: Mini-USB
- (6) Cover glass
 - ♦ Thickness: 1.1mm

1.3 Product Summary

Items	Specifications	Unit
Screen Diagonal	10.1	Inch
Pixel Format	1280(RGB) x800	-
Pixel Pitch	0.1695(H)×0.1695 (V)	mm
Pixel Arrangement	R.G.B. Vertical Stripe	-
Display Mode	Normally Black	-
White Luminance	298 (Тур.)	cd /m2
Contrast Ratio	800 : 1 (Typ.)	-
Response Time	25	msec
Input Voltage	3.3	V
Electrical Interface (Logic)	LVDS	-
Support Color	16.7M	-



1.4 Functional Block Diagram

Shows the functional block diagram of the LCD module

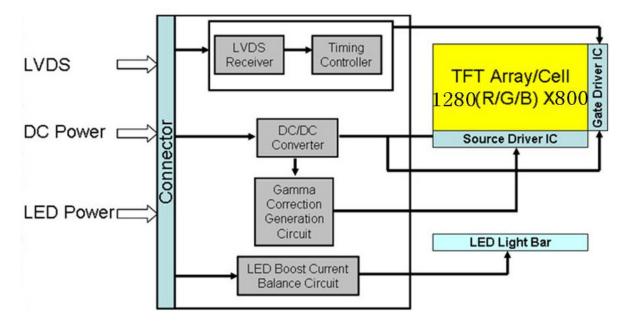


Figure 1 Block Diagram

Item	Symbol	Min	Max	Unit	Conditions
Logic Supply Voltage	VDD	-0.3	4.0	V	TA=25 ℃
Supply VLED Voltage	VLED	-0.3	24	V	TA=25 ℃

2. Absolute Maximum Ratings

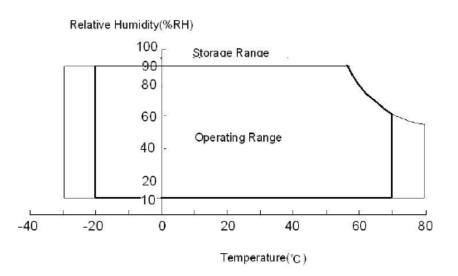
Item	Symbol	Min	Мах	Unit	Conditions
Operating Temperature	ТОР	-30	70	°C	Note
Operating Humidity	HOP		90	%RH	Note
Storage Temperature	TST	-30	80	°C	Note
Storage Humidity	HST		90	%RH	Note

Note(1) Maximum Wet-Bulb temperature should be 39 degree C and no condensation.

Note(2) When you apply the LCD module for OA system. Please make sure to keep the temperature of

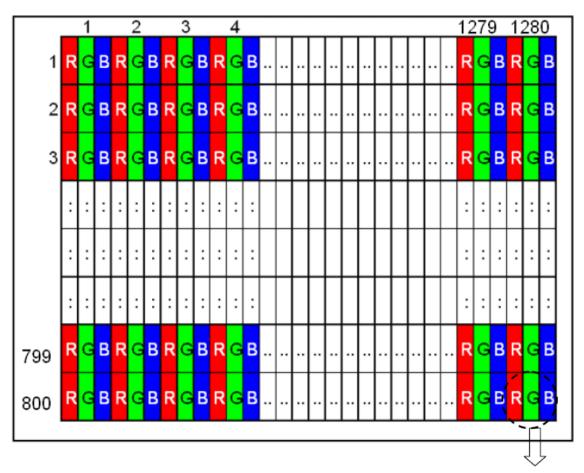
LCD module is less than $70^\circ\!\mathrm{C}$

Note(3) Storage /Operating temperature



3. Pixel Format Image

Shows the relationship of the input signals and LCD pixel format image



R+G+B dots=1 pixel

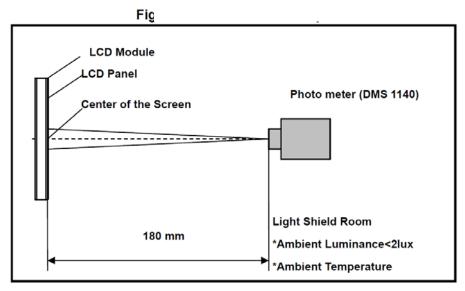
4. Optical Characteristics

The optical characteristics are measured under stable conditions as following notes

Item	Conditio	ons	Min.	Тур.	Max.	Unit	Note
	Horizontal	Θ x+	(75)	(85)	-		
Viewing Angle	HOHZOHIAI	θ x-	(75)	(85)	-	dograa	(4) (0) (2)
(CR>10)	Vertical	Θу+	(75)	(85)	-	degree	(1),(2),(3)
	ventical	Ө у-	(75)	(85)	-		
Contrast Ratio	Cente	r	(600)	(800)	-	-	(1),(2),(4)
	Rising	1	-	-	-	ms	
Response Time	Falling)	-	-	-	ms	(1),(2),(5)
	Rising + Fa	alling	-	25	-	ms	
	NTSC	;	-	45	-	%	(1),(2)
	Red	х		0.561		-	
	Red	у		0.334		-	
Color	Green	х		0.341		-	
Chromaticity	Green	У	Тур.	0.568	Тур.	-	(1) (2)
(CIE1931)	Blue	х	-0.05	0.161	+0.05	-	(1),(2)
	Blue	У		0.129		-	
	White	х		0.313		-	
	White	У		0.329		-	
White Luminance	Cente	r	238	298	-	cd/m^2	(1),(2),(6)
Luminance Uniformity	9Point	S	70	75	-	%	(1),(2),(6)

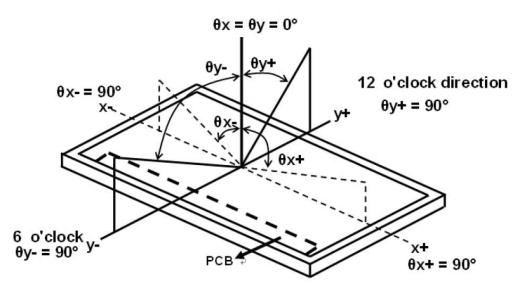
Note(1) Measurement Setup:

The LCD module should be stabilized at given temperature(25°C) for 15 minutes to Avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



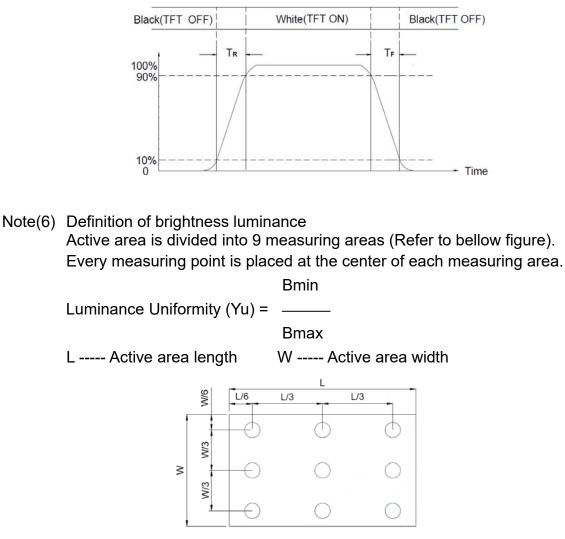
Note(2) The LED input parameter setting as:PWM: duty 100 %

Note(3) Definition of viewing angle:



Note(4) Definition of Contrast Ratio (CR) The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L255 / L0 L63: Luminance of gray level 255, L0: Luminance of gray level 0





Bmax: The measured maximum luminance of all measurement position. Bmin: The measured minimum luminance of all measurement position.

5. Backlight Characteristics

5.1 Parameter Guideline Of LED Backlight

Symbol	Paramet	er	Min.	Тур.	Max.	Units	Condition
VLED	LED Inp	ut	(6)	(12)	(21)	[V]	Ta=25℃ Note B
PLED	LED Pow Consumpt		-	-	(2.5)	W	Ta=25℃ Note B
	PWM	High	3.0		3.6	V	Ta=25 ℃
VLED_PWM	Signal Voltage	Low	0		0.4	V	1a-25 (
			100	-	200		DDIM≥0.1%
			200	-	500	Hz	DDIM≥0.25%
			500	-	1000		DDIM≥0.5%
FPWM	PWM dimn	ning	1000	-	2000		DDIM≥1%
	Frequen	су	2000	-	5000		DDIM≥2.5%
			5000	-	10000		DDIM≥5%
			10000	-	20000		DDIM≥10%
			20000	-	30000		DDIM≥15%
	LED Enable	High	3.0		3.6	V	
VLED_EN	Voltage	Low	0		0.4	V	-
LT	LED Life Time		20,000	25,000	-	Hours	Ta=25℃ Note A

Note A: The LED life time define as the estimated time to 50% degradation of initial luminous.

Note B: A higher LED power supply voltage will result in better power efficiency. Keep the VLED between 12V and 12.6V is strongly recommended.

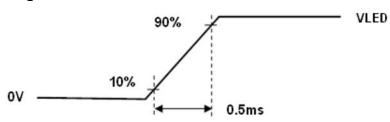
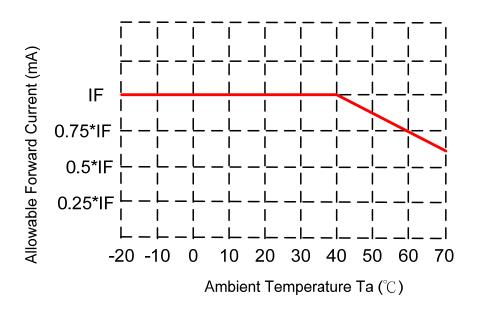


Figure 7 LED Rush Current Measure Condition

VLED rising time





6. Electrical Characteristics

6.1 TFT LCD Module Interface Connector

Table 4 Connector Name / Designation

	ltem		Description	
N	lanufacturer / Part N	umber	Starconn / 300E40-0010RA-G3	
Mating Model Number		TBD or compatible		
		Table 5 Sign	al Pin Assignment	
Pin #	Signals Name		Description	Remarks
1	NC		Not Connect	-
2	VDD	Powe	er Supply, 3.3V (typical)	-
3	VDD	Powe	er Supply, 3.3V (typical)	
4	VDD_EDID	Power S	upply for EDID I2C Flash IC	
5	SCL_EDID	I2C Serial	Clock for EDID I2C Flash IC	
6	SDA_EDID	I2C Seria	I Data for EDID I2C Flash IC	
7	NC		Not Connect	
8	LV0N	-LVE	S differential data input	
9	LV0P	+LVDS differential data input		
10	GND		Ground	
11	LV1N	-LVE	-LVDS differential data input	
12	LV1P	+LVE	+LVDS differential data input	
13	GND		Ground	
14	LV2N	-LVE	S differential data input	
15	LV2P	+LVE	DS differential data input	
16	GND		Ground	
17	LVCLKN	-LVE	S differential data input	
18	LVCLKP	+LVE	DS differential data input	
19	GND		Ground	
20	LV3N	-LVE	S differential data input	
21	LV3P	+LVE	DS differential data input	
22	GND		Ground	
23	LED_GND	Gi	ound for LED Driving	
24	LED_GND	Gi	ound for LED Driving	
25	LED_GND	Gi	ound for LED Driving	

26	NC	Not Connect	
27	LED_PWM	PWM Input signal for LED driver	
28	LED_EN	LED Enable Pin	
29	NC	Not Connect	
30	NC	Not Connect	
31	LED_VCC	Power Supply for LED Driver	
32	LED_VCC	Power Supply for LED Driver	
33	LED_VCC	Power Supply for LED Driver	
34	NC	Not Connect	
35	BIST	BIST pin. (Keep NC or GND if not use.)	
36	NC	Not Connect	
37	NC	Not Connect	
38	NC	Not Connect	
39	NC	Not Connect	
40	NC	Not Connect	

Note: All input signals shall be low or Hi-resistance state when VDD is off.

6.2 LVDS Receiver

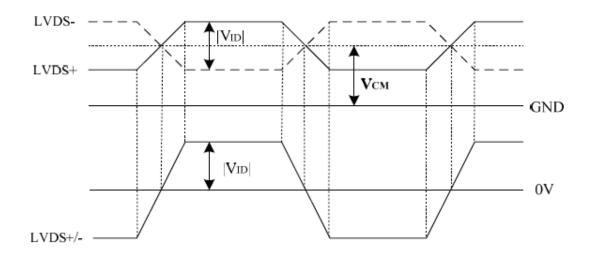
621	Signal Electrical Characteristics For LVDS Receiver
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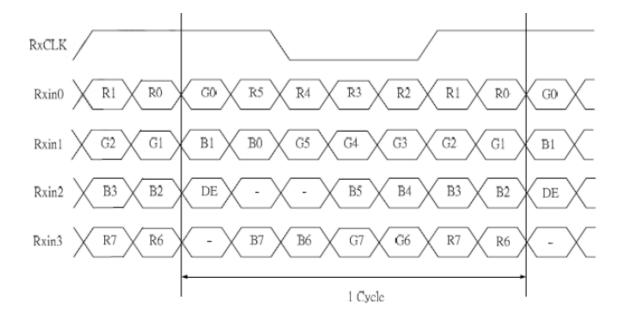
Table 7 LVDS Receiver Electrical Characteristics
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Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Differential Input High	Vth	-	-	+100	mV	V _{CM} =+1.2V
Differential Input Low	∨tI	-100	-	-	m٧	V _{CM} =+1.2V
Magnitude Differential Input	VID	200	-	400	m٧	-
Common Mode Voltage	V _{CM}	0.3+ (VID/2)	-	VDD-1.2-(VID/2)	V	-
Common Mode Voltage	ΔV_{CM}	-	-	50	mV	V _{CM} =+1.2V

Note (1) Input signals shall be low or Hi-Z state when VDD is off.

(2) All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD.





7. Interface Timings

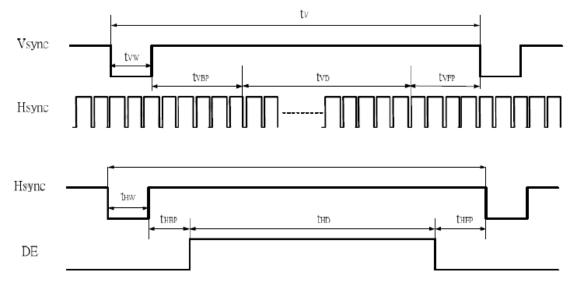
7.1 Timing Characteristics

-					
Parameter	Symbol	Min.	Тур.	Max.	Unit
LVDS Clock Frequency	Fclk	(70.0)	(72.4)	(76.6)	MHz
H Total Time	HT	(1,410)	(1,440)	(1,470)	Clocks
H Active Time	HA		1,280		Clocks
∨ Total Time	VT	(828)	(838)	(868)	Lines
V Active Time	VA		800		Lines
Frame Rate	F۷	-	(60)	-	Hz

Note1: HT * VT *Frame Frequency≤(76.6) MHz

Note2: All reliabilities are specified for timing specification based on refresh rate of 60Hz.

7.2 Timing Diagram of Interface Signal (DE mode)

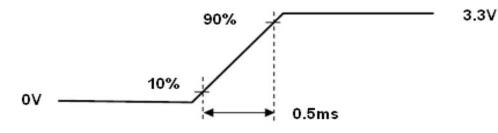


8. Power Consumption

Input power specifications are as follows.

lten	1	Symbol	Min.	Тур.	Max.	Unit	Note
LCD Drive	Voltage	VDD	3.0	3.3	3.6	V	(3)
VDD Current	White Pattern	IDD		0.295	-	А	(2),(3)
VDD Power Consumption	White Pattern	PDD			1.2	W	(2),(3)
LED Power Co	onsumption	PLED			2.5	W	(2),(3)
Rush Cu	urrent	Irush			1.5	A	(1),(3),(4)
Allowable Logic/LCD Drive Ripple Voltage VDDrp		VDDrp			300	mV	(3)

Note (1) Measure Condition

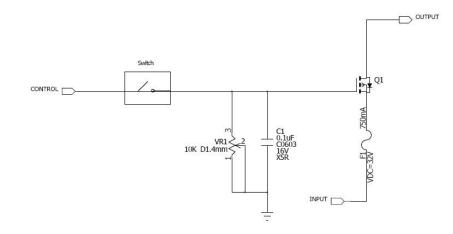


VDD rising time

Note (2) Frame Rate=60Hz, VDD=3.3V, DC Current.

Note (3) Operating temperature $25^\circ\!\mathbb{C}$, humidity 55%RH.

Note (4) Reference measurement circuit of rush current is shown below.



9. Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.

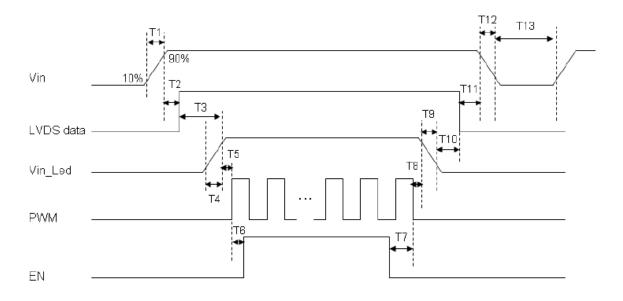


Figure 11 Power Sequence

Table 9 Power Sequencing Requirements

Parameter	Symbol	Unit	Min	Тур.	Max
VIN Rise Time	T1	ms	0.5		10
VIN Good to Signal Valid	T2	ms	30		90
Signal Valid to Backlight On	Т3	ms	200		
Backlight Power On Time	T4	ms	0.5		
Backlight VDD Good to System PWM On	T5	ms	10		
System PWM ON to Backlight Enable ON	T6	ms	10		
Backlight Enable Off to System PWM Off	T7	ms	0		
System PWM Off to B/L Power Disable	Т8	ms	10		
Backlight Power Off Time	Т9	ms		10	30
Backlight Off to Signal Disable	T10	ms	200		
Signal Disable to Power Down	T11	ms	0		50
VIN Fall Time	T12	ms		10	30
Power Off	T13	ms	500		

10. Projected Capacitive-type Touch Panel Specification 10.1 Basic Characteristic

Item	Specification			
Туре	Projective Capacitive Touch Panel			
Activation	Multi-fingers or Single-finger			
X/Y Position Reporting	Absolute Position			
Touch ForceNo contact pressure required				
Calibration	No need for calibration			
Report Rate	Approx. 80 points/sec			
Control IC	EETI EXC3146			

10.2 Electrical Absolute Max Rating

Itom	Symbol	Symbol Value		Unit	Note	
ltem	n Symbol		Max.	Unit		
Power supply voltage	VIN	-0.3	5.5	V	GND=0V	

10.3 Electrical Characteristics

Specify the normal operating condition (GND=0V)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Power supply voltage	VIN	4.75	5	5.25	V	

10.4 Interface

Pin No.	Symbol	Function
1	PVDD	Power supply.
2	DA-	USB Data
3	DA+	USB Data+.
4	NC	Please keep this pin NC.
5	PGND	Ground.

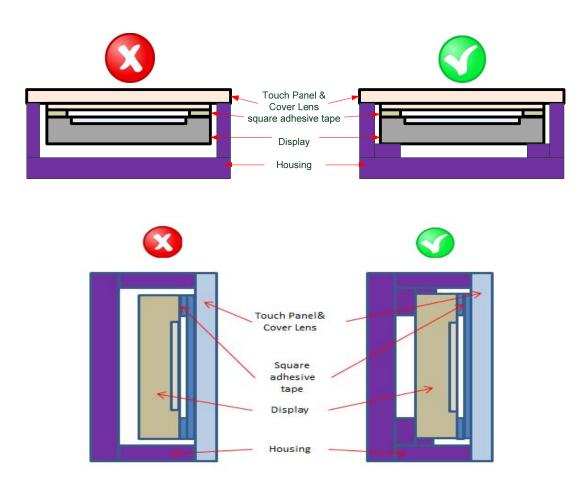
11. Use Precautions

11.1 Handling precautions

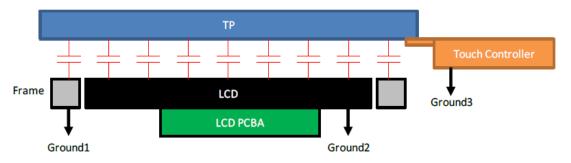
- 1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- 2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- 3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- 4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

11.2 Installing precautions

- (1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. $1M\Omega$ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- (2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- (3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- (4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.
- (5) Please hold the LCD module properly when you use or store it.
- (6) The square adhesive tape which is between the touch panel and display can't provide well supporting in the long term and high ambient temperature condition. Whether upright or horizontal position the support holder which is in the back side of the display is needed. Do not let the display floating.



(7) TP needs to work in environment with stable stray capacitance. In order to minimize the variation in stray capacitance, all conductive mechanical parts must not be floating. Intermittent floating any conductive part around the touch sensor may cause significant stray capacitance change and abnormal touch function. It is recommended to keep all conductive parts having same electrical potential as the GND of the touch controller module.



GND1, GND2 and GND3 should be connected together to have the same ground

11.3 Storage precautions

- (1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- (2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- (3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

11.4 Operating precautions

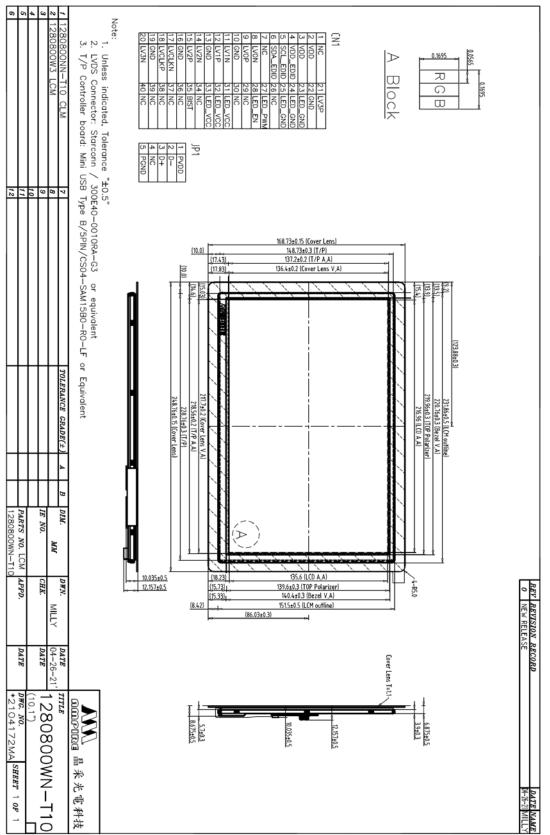
- (1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- (2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- (3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- (4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- (5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- (6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
- (7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.

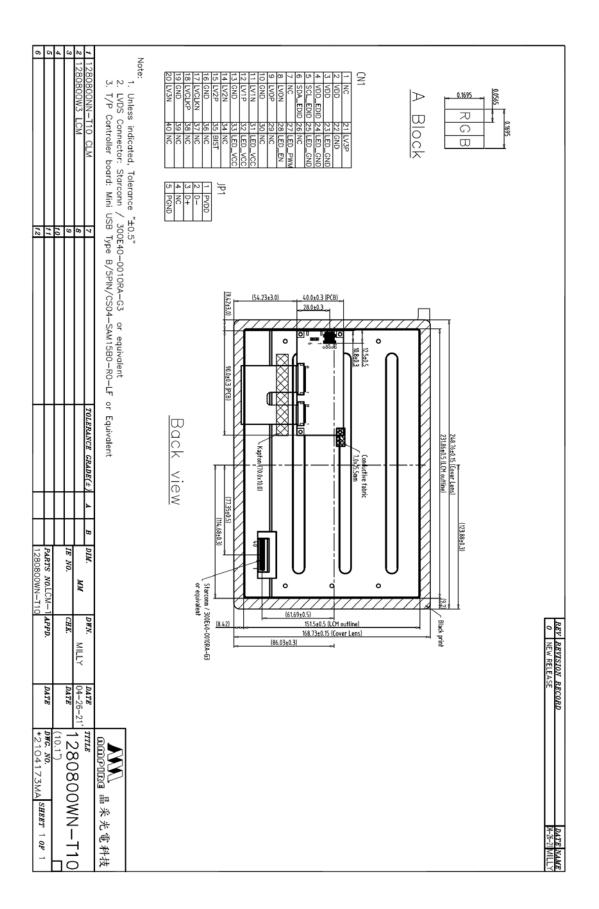
(8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

11.5 Other

- 1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2) Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver.
- 3) AMIPRE will provide one year warrantee for all products and three months warrantee for all repairing products.

12. Mechanical Drawing





13. Package TBD